



AF/2800

WMP-EUP-008

**BOX AF**

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By: 

Date: 12/10/2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 10/056,770 Confirmation No. 4597  
Applicant : Gottfried Ferber et al.  
Filed : January 24, 2002  
TC/A.U. : 2818  
Examiner : Long K. Tran  
Title : Semiconductor Module and Method for  
Fabricating the Semiconductor Module  
Docket No. : WMP-EUP-008  
Customer No. : 24131

**BOX AF**

Hon. Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

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**AMENDMENT under 37 C.F.R. § 1.116**

S i r :

In response to the final Office action dated September 10, 2003, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 5 of this paper.